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#### November 2013



# FDD5N60NZ N-Channel UniFET<sup>™</sup> II MOSFET **600 V, 4.0 A, 2** Ω

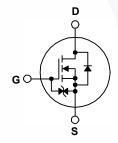
## **Features**

- R<sub>DS(on)</sub> = 1.65 Ω (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 2.0 A
- Low Gate Charge (Typ. 10 nC)
- Low C<sub>rss</sub> (Typ. 5 pF)
- 100% Avalanche Tested
- · Improved dv/dt Capability
- · ESD Imoroved Capability
- · RoHS Compliant

# Applications

- LCD/LED/PDP TV
- Lighting
- · Uninterruptible Power Supply

# D-PAK



Description

lasts.

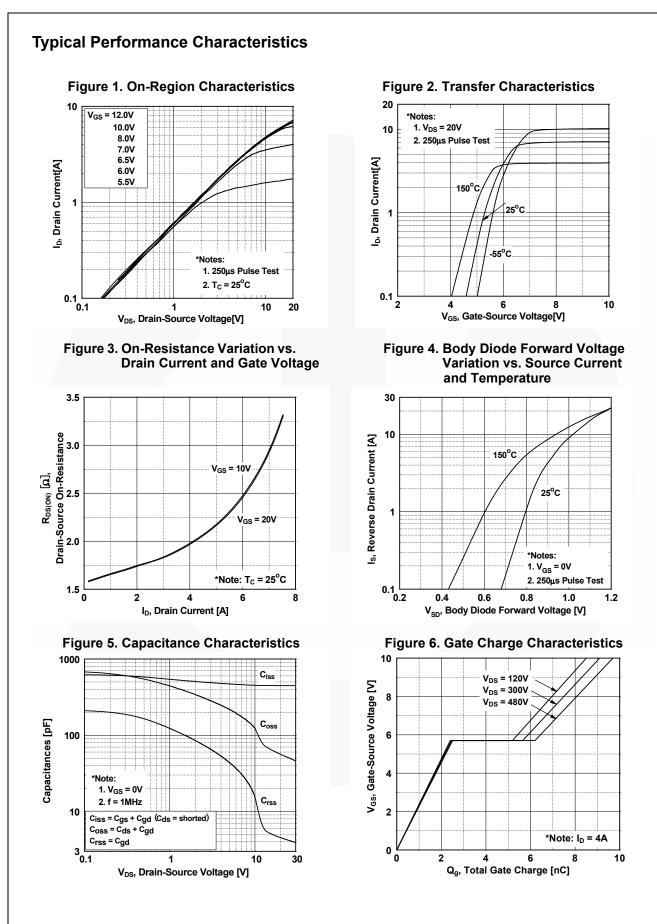
### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter		FDD5N60NZ	Unit
V <sub>DSS</sub>	Drain to Source Voltage		600	V
V <sub>GSS</sub>	Gate to Source Voltage		±25	V
	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)	4.0	Α
D		- Continuous ( $T_c = 100^{\circ}C$ )	2.4	
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	16	Α
E <sub>AS</sub>	Single Pulsed Avalanche En	216	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)		4.0	Α
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		8.3	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		10	V/ns
P <sub>D</sub>	Power Dissipation	$(T_{C} = 25^{\circ}C)$	83	W
		- Derate Above 25 <sup>o</sup> C	0.7	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

## **Thermal Characteristics**

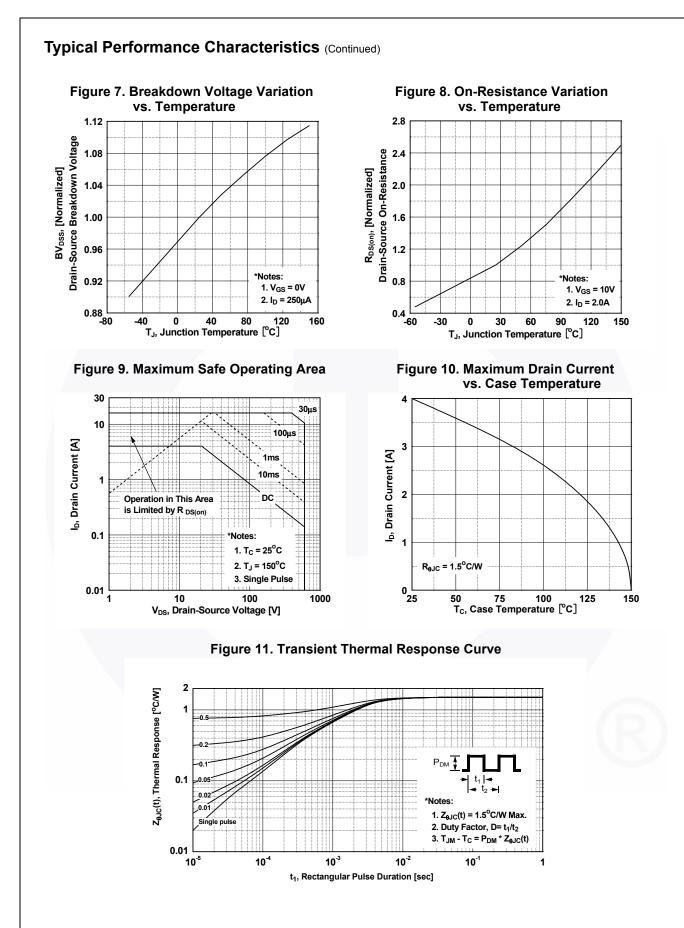
Symbol	Parameter	FDD5N60NZ	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	1.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	90	0/11

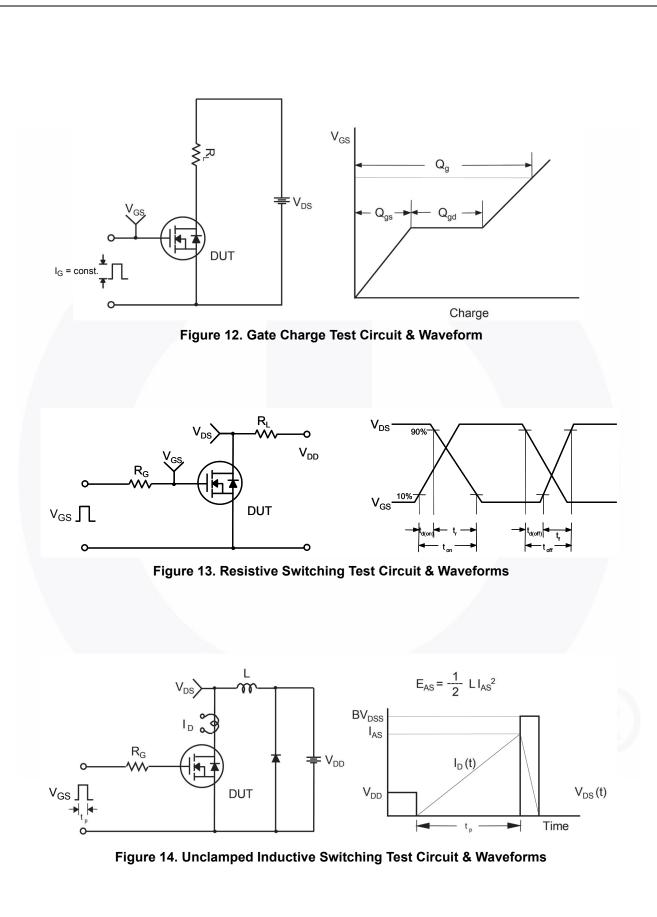
Part Number Top Mark F		Package	ackage Packing Method Reel Size		e Tape Width		Qu	antity	
FDD5N60NZTM FDD5N60NZ		DPAK	Tape and Reel	330 mm		16 mm	2500 units		
Electrical	Chara	icteristics T <sub>C</sub> = 25°C u	inless other	wise noted.					
Symbol		Parameter		Test Conditions	S	Min.	Тур.	Max.	Unit
Off Charac	teristics								
BV <sub>DSS</sub>	Drain to S	Source Breakdown Voltage	lo =	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 25 <sup>o</sup> C		600	-	_	V
ΔBV <sub>DSS</sub>		vn Voltage Temperature		$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C					
$\Delta T_{\rm J}$	Coefficier	<b>o</b> 1	I <sub>D</sub> =			-	0.6	-	V/ºC
	7			V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	-	50	
DSS	Zero Gat	e Voltage Drain Current	$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		-	-	100	μA	
I <sub>GSS</sub>	Gate to E	Body Leakage Current	V <sub>GS</sub>	= ±25 V, V <sub>DS</sub> = 0 V		-	-	±10	μA
On Charao									
On Charact									
V <sub>GS(th)</sub>		eshold Voltage		<sub>S</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA		3.0	-	5.0	V
R <sub>DS(on)</sub>		ain to Source On Resistance		<sub>S</sub> = 10 V, I <sub>D</sub> = 2.0 A		-	1.65	2.00	Ω
9 <sub>FS</sub>	Forward	Transconductance	V <sub>DS</sub>	<sub>s</sub> = 20 V, I <sub>D</sub> = 2.0 A		-	5	-	S
Dynamic C	haracte	ristics							
C <sub>iss</sub>	Input Cap	pacitance				-	450	600	pF
C <sub>oss</sub>	Output C	apacitance		V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	50	65	pF
C <sub>rss</sub>		Transfer Capacitance	f = 1			-	5	7.5	pF
Q <sub>g(tot)</sub>	Total Gat	e Charge at 10V		V <sub>DS</sub> = 400 V, I <sub>D</sub> = 4.0 A, V <sub>GS</sub> = 10 V		-	10	13	nC
Q <sub>gs</sub>		Source Gate Charge	V <sub>DS</sub>			-	2.5	-	nC
Q <sub>gd</sub>		)rain "Miller" Charge	V <sub>G</sub>				4	-	nC
-					(Note 4)		•		
Switching	1						1 1		
t <sub>d(on)</sub>		Delay Time		$V_{DD} = 250 \text{ V}, \text{ I}_{D} = 4.0 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{G} = 25 \Omega$ (Note 4)		-	15	40	ns
t <sub>r</sub>		Rise Time				-	20	50	ns
t <sub>d(off)</sub>	Turn-Off I	Delay Time	VGS			-	35	80	ns
t <sub>f</sub>	Turn-Off	Fall Time				- /	20	50	ns
Drain-Sour	ce Diod	e Characteristics							
I <sub>S</sub>	Maximum	Continuous Drain to Source	e Diode For	ward Current		-	-	4.0	А
I <sub>SM</sub>	Maximum	Pulsed Drain to Source Dio	de Forward	Forward Current		-	-	16	Α
V <sub>SD</sub>	Drain to S	Source Diode Forward Voltag	ye V <sub>GS</sub>	<sub>s</sub> = 0 V, I <sub>SD</sub> = 4.0 A		-	-	1.4	V
t <sub>rr</sub>	Reverse I	Recovery Time		$V_{GS} = 0 V, I_{SD} = 4.0 A,$		-	230	-	ns
Q <sub>rr</sub>		Recovery Charge	$dI_{F}/dt = 100 A/\mu s$		-	0.9		μC	
Notes: 1. Repetitive rating: 2. L = 27 mH, I <sub>AS</sub> =	pulse-width lin 4.0 A, V <sub>DD</sub> = 5	mited by maximum junction temperatu 50 V, $R_G = 25 \Omega$ , starting $T_J = 25^{\circ}C$ . $D_D \leq BV_{DSS}$ , starting $T_J = 25^{\circ}C$ .		α. 10070μ3		-	0.9	6	



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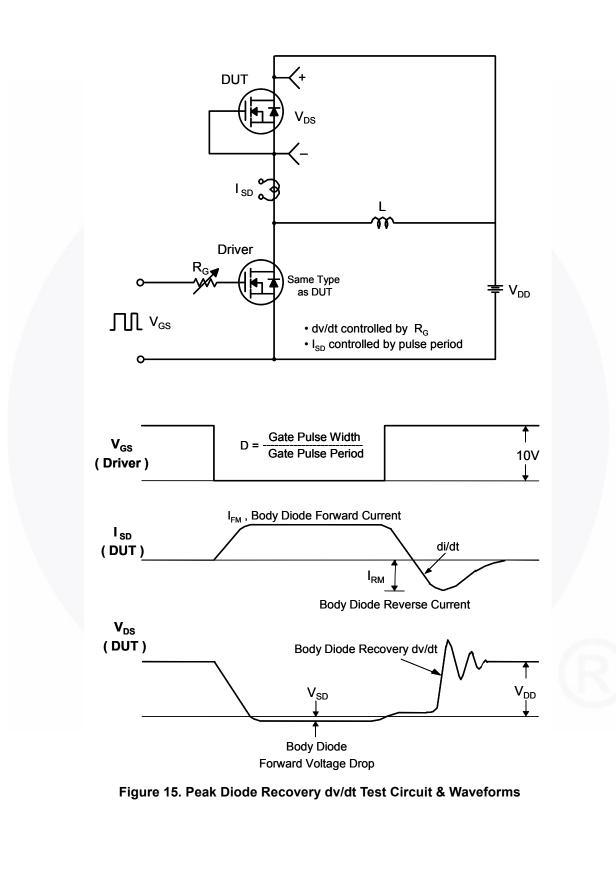


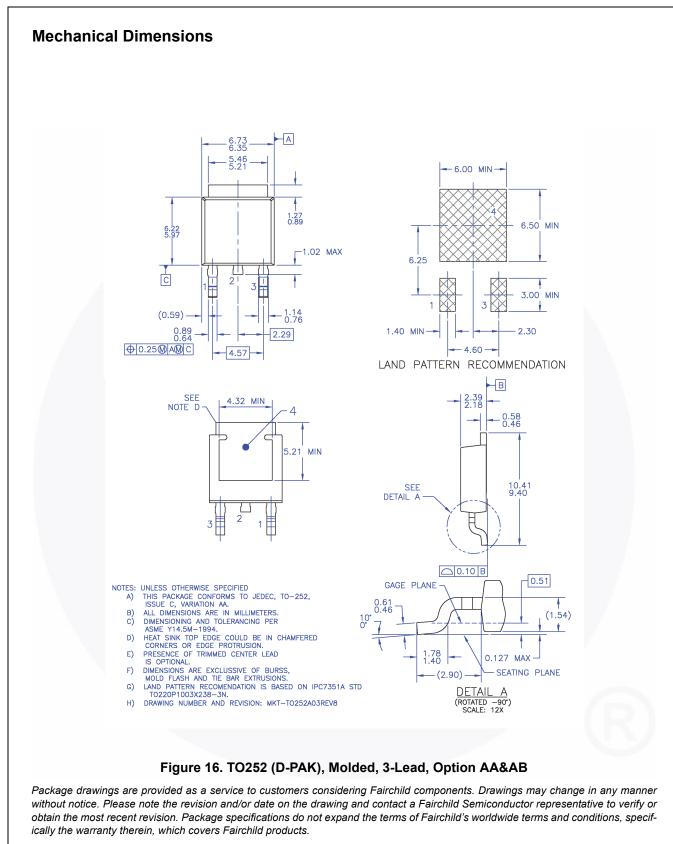




FDD5N60NZ — N-Channel UniFET<sup>TM</sup> II MOSFET

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